

2A, 100V - 200V Ultra Fast Surface Mount Rectifier

FEATURES

- Planar technology
- Low power loss, high efficiency
- Ideal for automated placement
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

APPLICATIONS

- High frequency switching
- DC/DC
- Snubber

MECHANICAL DATA

- Case: DO-214AA (SMB)
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 2 whisker test
- Polarity: Indicated by cathode band
- Weight: 0.087g (approximately)

KEY PARAMETERS		
PARAMETER	VALUE	UNIT
I_F	2	A
V_{RRM}	100 - 200	V
I_{FSM}	50	A
$T_{J\ MAX}$	175	°C
Package	DO-214AA (SMB)	
Configuration	Single die	



DO-214AA (SMB)



ABSOLUTE MAXIMUM RATINGS (T _A = 25°C unless otherwise noted)					
PARAMETER		SYMBOL	PE2BB	PE2DB	UNIT
Marking code on the device			PE2BB	PE2DB	
Repetitive peak reverse voltage		V _{RRM}	100	200	V
Reverse voltage, total rms value		V _{R(RMS)}	70	140	V
Forward current		I _F	2		A
Surge peak forward current single half sine-wave superimposed on rated load	t = 8.3ms	I _{FSM}	50		A
	t = 1.0ms		130		
Junction temperature		T _J	-55 to +175		°C
Storage temperature		T _{STG}	-55 to +175		°C

THERMAL PERFORMANCE

PARAMETER	SYMBOL	TYP	UNIT
Junction-to-lead thermal resistance	$R_{\theta JL}$	18	°C/W
Junction-to-ambient thermal resistance	$R_{\theta JA}$	67	°C/W
Junction-to-case thermal resistance	$R_{\theta JC}$	19	°C/W

Thermal Performance Note: Units mounted on PCB (10mm x 10mm Cu pad test board)

ELECTRICAL SPECIFICATIONS ($T_A = 25^\circ\text{C}$ unless otherwise noted)

PARAMETER	CONDITIONS	SYMBOL	TYP	MAX	UNIT
Forward voltage ⁽¹⁾	$I_F = 1\text{A}, T_J = 25^\circ\text{C}$	V_F	0.81	-	V
	$I_F = 2\text{A}, T_J = 25^\circ\text{C}$		0.87	0.90	V
	$I_F = 1\text{A}, T_J = 125^\circ\text{C}$		0.65	-	V
	$I_F = 2\text{A}, T_J = 125^\circ\text{C}$		0.72	-	V
Reverse current @ rated V_R ⁽²⁾	$T_J = 25^\circ\text{C}$	I_R	-	2	μA
	$T_J = 125^\circ\text{C}$		-	10	μA
Junction capacitance	1MHz, $V_R = 4.0\text{V}$	C_J	30	-	pF
Reverse recovery time	$I_F = 0.5\text{A}, I_R = 1.0\text{A}, I_{rr} = 0.25\text{A}$	t_{rr}	-	20	ns
	$I_F = 1.0\text{A}, di/dt = 50\text{A}/\mu\text{s}, V_R = 30\text{V}$		24	-	
Reverse recovery current	$I_F = 2.0\text{A}, di/dt = 200\text{A}/\mu\text{s}, V_R = 100\text{V}$	I_{RM}	2.7	-	A
Reverse recovery charge		Q_{rr}	17.4	-	nC
Reverse recovery time		t_{rr}	14	-	ns

Notes:

1. Pulse test with $PW = 0.3\text{ms}$
2. Pulse test with $PW = 30\text{ms}$

ORDERING INFORMATION

ORDERING CODE ⁽¹⁾	PACKAGE	PACKING
PE2xB	DO-214AA (SMB)	3,000/ Tape & Reel

Notes:

1. "x" defines voltage from 100V(PE2BB) to 200V(PE2DB)

CHARACTERISTICS CURVES

($T_A = 25^\circ\text{C}$ unless otherwise noted)

Fig.1 Forward Current Derating Curve

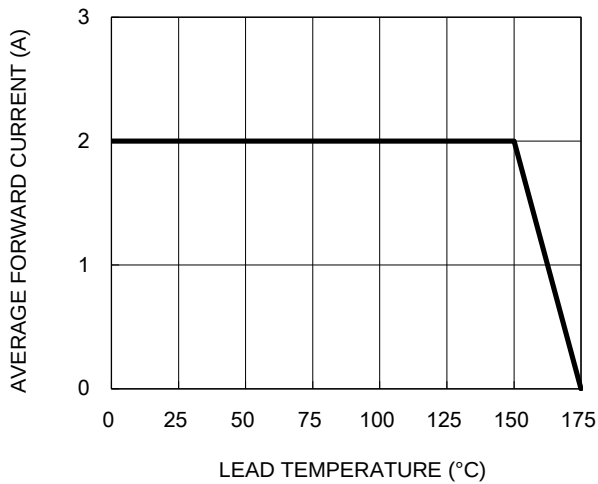


Fig.2 Typical Junction Capacitance

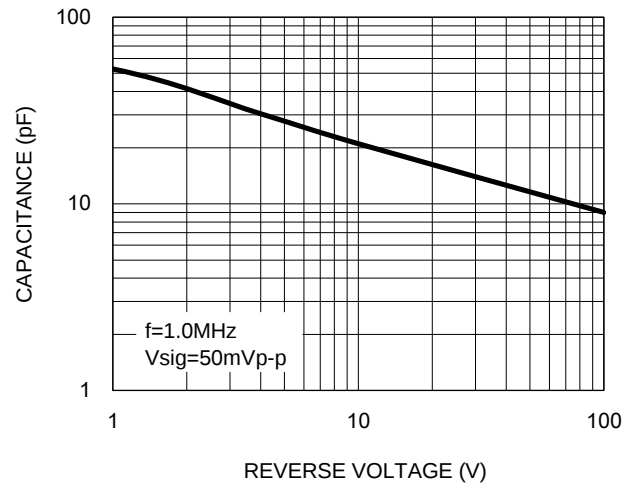


Fig.3 Typical Reverse Characteristics

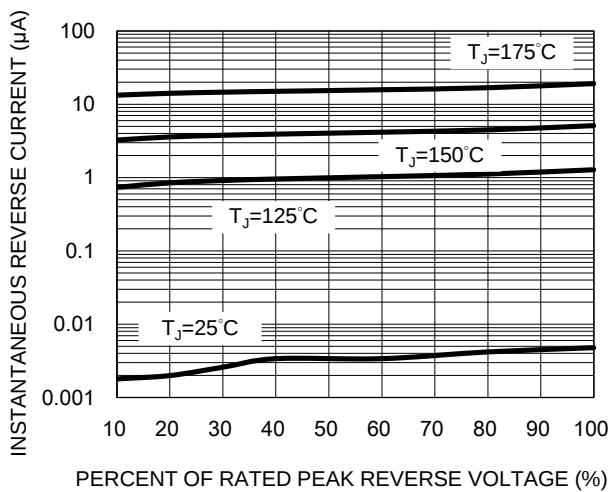


Fig.4 Typical Forward Characteristics

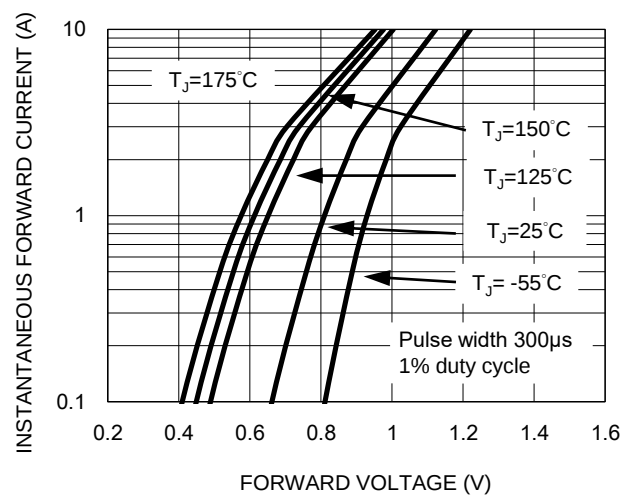
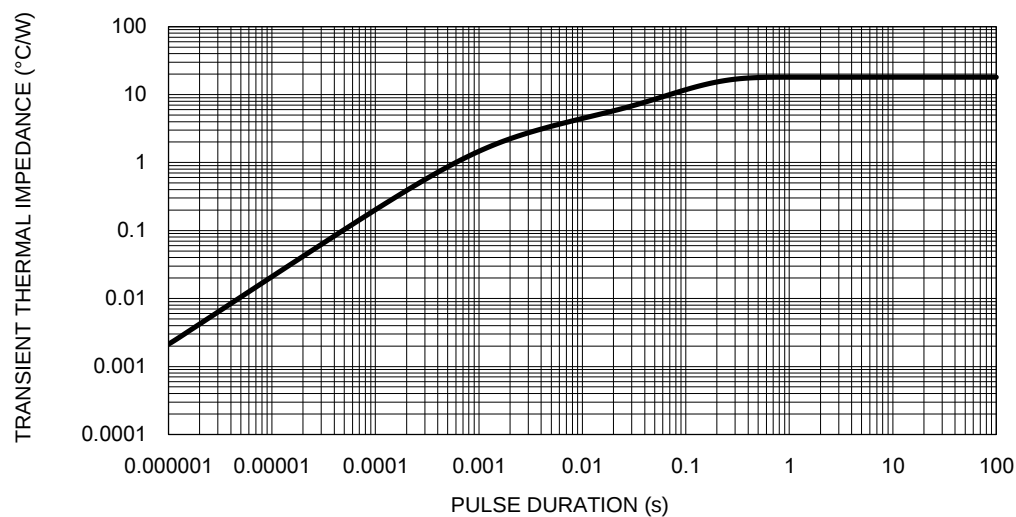
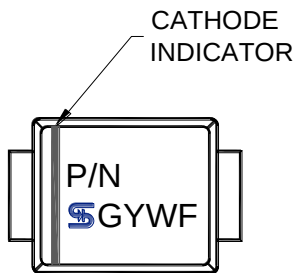
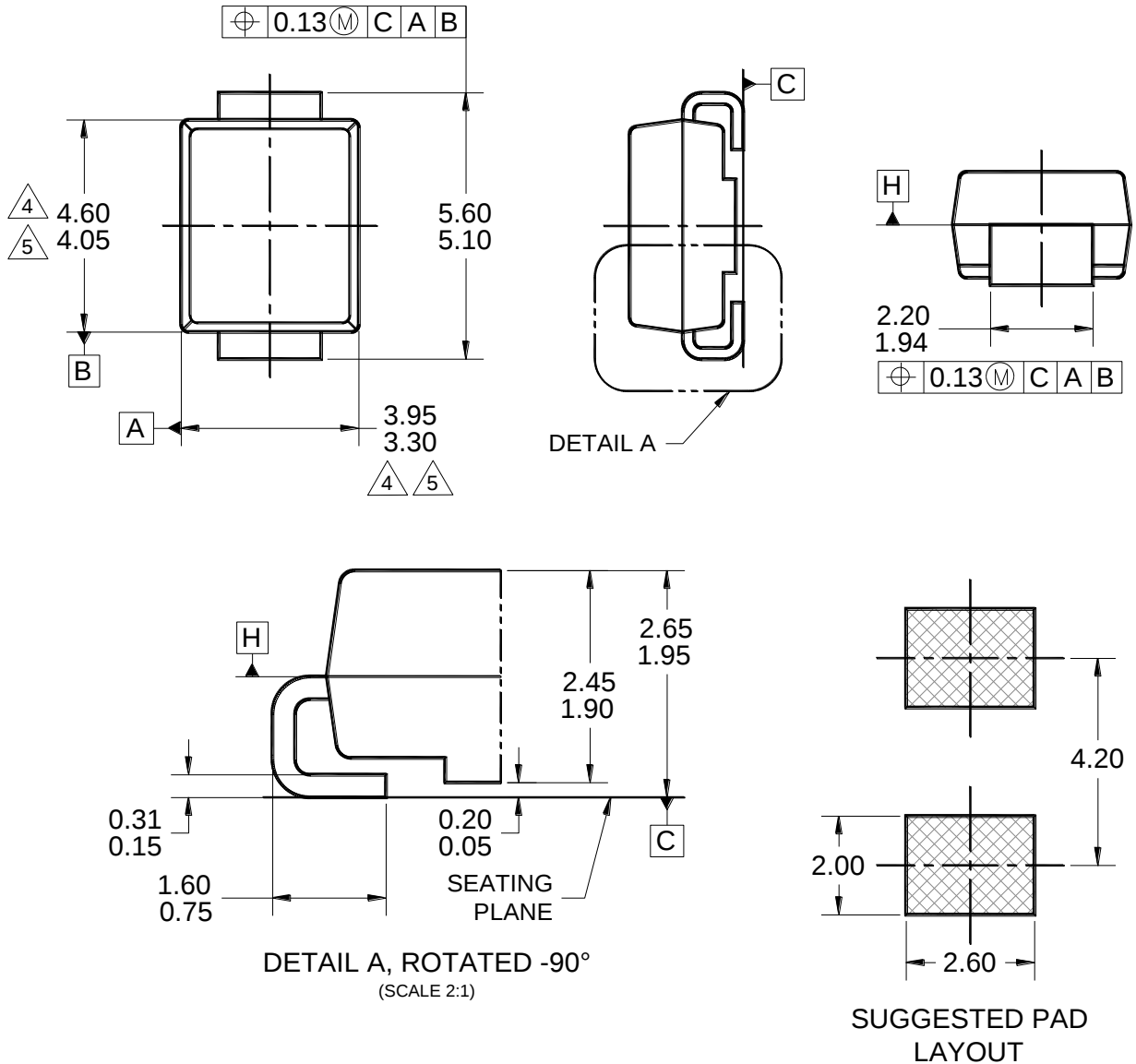


Fig.5 Typical Transient Thermal Impedance



PACKAGE OUTLINE DIMENSIONS

DO-214AA (SMB)



MARKING DIAGRAM

P/N = MARKING CODE
G = GREEN COMPOUND
YW = DATE CODE
F = FACTORY CODE

NOTES: UNLESS OTHERWISE SPECIFIED

- ALL DIMENSIONS ARE IN MILLIMETERS.
- DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994.
- PACKAGE OUTLINE REFERENCE: JEDEC DO-214, VARIATION AA, ISSUE D.
- MOLDED PLASTIC BODY DIMENSIONS DO NOT INCLUDE MOLD FLASH.
- MOLDED PLASTIC BODY LATERAL DIMENSIONS TO BE DETERMINED AT DATUM PLANE H.
- DWG NO. REF: HQ2SD07-DO214SMB-035 REV A.

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